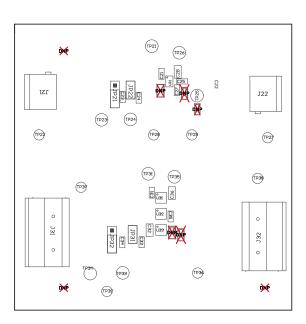
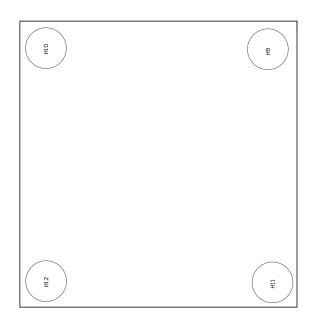
- ZZI mInstall label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- $\mbox{ZZ2} \blacksquare \mbox{These}$ assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable. ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Rev. A

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00513	REV: A	SVN REV	: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 3/15/2	015 10:33:11	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Rev. A

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00513	REV: A	SVN REV: Not In VersionControl	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/15/2	2015 10:33:11	AM	TEXAS INSTRUMENTS

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